

High linearity wideband silicon NPN RF bipolar transistor



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Product description

The BFP650 is a RF bipolar transistor based on SiGe:C technology that is part of Infineon's established sixth generation transistor family. Its transition frequency $f_{\rm T}$ of 42 GHz and high linearity characteristics at low currents make the device suitable for energy efficiency designs at frequency as high as 5 GHz. It remains cost competitive without compromising on ease of use.



Feature list

- Minimum noise figure NF_{min} = 1 dB at 2.4 GHz, 3 V, 30 mA
- High gain G_{ma} = 17.5 dB at 2.4 GHz, 3 V, 70 mA
- OIP₃ = 30 dBm at 2.4 GHz, 3 V, 70 mA

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Low noise, high linearity amplifiers in SDARS receivers
- Low noise, high linearity amplifiers for ISM band applications
- Low noise, high linearity amplifiers for multimedia applications such as CATV

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin co	nfigura	tion		Marking	Pieces / Reel
BFP650 / BFP650H6327XTSA1	SOT343	1 = B	2 = E	3 = C	4 = E	R5s	3000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

Absolute maximum ratings 1

Table 2 Absolute maximum ratings at $T_A = 25$ °C (unless otherwise specified)

Parameter	Symbol	Symbol Values			Note or test condition	
		Min.	Max.			
Collector emitter voltage	V_{CEO}	_	4.0	٧	Open base	
			3.7		T _A = -55 °C, open base	
Collector emitter voltage	V _{CES}		13		E-B short circuited	
Collector base voltage	V_{CBO}		13		Open emitter	
Emitter base voltage	V_{EBO}		1.2		Open collector	
Base current	I _B		10	mA	_	
Collector current	Ic		150			
Total power dissipation ¹⁾	P _{tot}		500	mW	<i>T</i> _S ≤ 78 °C	
Junction temperature	TJ		150	°C	-	
Storage temperature	T_{Stg}	-55				

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

 T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.



Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Junction - soldering point	R _{thJS}	_	140	_	K/W	-

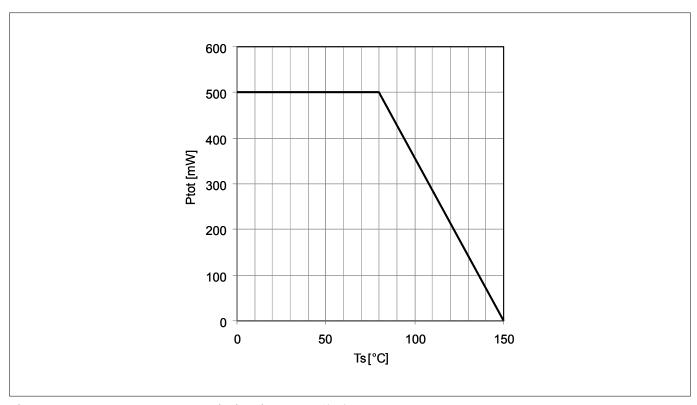


Figure 1 Total power dissipation $P_{\text{tot}} = f(T_s)$



Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25$ °C

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Collector emitter breakdown voltage	V _{(BR)CEO}	4	4.5	-	V	$I_C = 3 \text{ mA}, I_B = 0,$ open base
Collector emitter leakage current	I _{CES}	_	0.1	1 ²⁾	μΑ	$V_{CE} = 13 \text{ V}, V_{BE} = 0,$ E-B short circuited
			1	40 ²⁾	nA	$V_{CE} = 5 \text{ V}, V_{BE} = 0,$ E-B short circuited
Collector base leakage current	I _{CBO}		1	40 ²⁾		$V_{\text{CB}} = 5 \text{ V}, I_{\text{E}} = 0,$ open emitter
Emitter base leakage current	I _{EBO}		10	500 ²⁾		$V_{\text{EB}} = 0.5 \text{ V}, I_{\text{C}} = 0,$ open collector
DC current gain	h _{FE}	100	170	250		$V_{CE} = 3 \text{ V}, I_{C} = 5 \text{ mA},$ pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25 \,^{\circ}\text{C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Transition frequency	f_{T}	31	42	-	GHz	$V_{CE} = 3 \text{ V}, I_{C} = 70 \text{ mA},$ f = 1 GHz
Collector base capacitance	ССВ	_	0.26	0.4	pF	$V_{\text{CB}} = 3 \text{ V}, V_{\text{BE}} = 0,$ f = 1 MHz, emitter grounded
Collector emitter capacitance	C _{CE}		0.45	_		$V_{CE} = 3 \text{ V}, V_{BE} = 0,$ f = 1 MHz, base grounded
Emitter base capacitance	C _{EB}		1.3			$V_{\text{EB}} = 0.5 \text{ V}, V_{\text{CB}} = 0,$ f = 1 MHz, collector grounded

² Maximum values not limited by the device but by the short cycle time of the 100% test.



3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_{\rm A}$ = 25 °C.

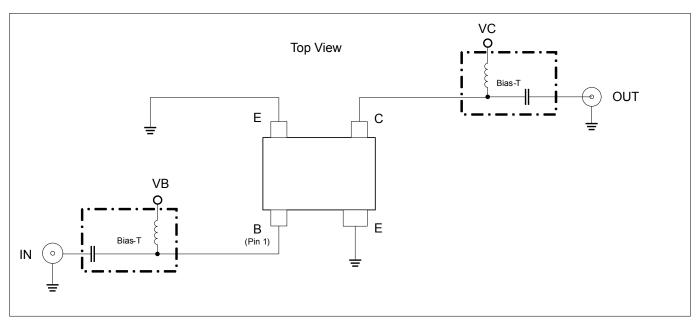


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 150 MHz

Parameter	Symbol	Values		Values Unit		Note or test condition
		Min.	Тур.	Мах.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		38			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		37.5			
Noise figure						
Minimum noise figure	<i>NF</i> _{min}		0.75			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		32			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		29.5			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		16.5			

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Electrical characteristics

Table 7 AC characteristics, $V_{CE} = 3 \text{ V}, f = 450 \text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		31.5			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		29.5			
Noise figure						
 Minimum noise figure 	NF _{min}		0.75			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		29.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		30			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \text{ G}$
• 1 dB gain compression point at output	OP _{1dB}		16.5			

Table 8 AC characteristics, $V_{CE} = 3 \text{ V}, f = 900 \text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		26.5			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		24			
Noise figure						
Minimum noise figure	NF _{min}		0.8			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		24.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		31			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		17			

Table 9 AC characteristics, $V_{CE} = 3 \text{ V}, f = 1.5 \text{ GHz}$

Parameter	Symbol		Values		Values Uni		Unit	Note or test condition
		Min.	Тур.	Max.				
Power gain		_		_	dB			
Maximum power gain	G _{ms}		22.5			$I_{\rm C} = 70 {\rm mA}$		
Transducer gain	$ S_{21} ^2$		19.5					
Noise figure								
Minimum noise figure	<i>NF</i> _{min}		0.85			$I_{\rm C} = 30 {\rm mA}$		
Associated gain	G _{ass}		20.5					
Linearity					dBm			
3rd order intercept point at output	OIP ₃		31			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$		
• 1 dB gain compression point at output	OP _{1dB}		17					

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Electrical characteristics

Table 10 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 1.9 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
 Maximum power gain 	G _{ms}		20			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		17.5			
Noise figure						
 Minimum noise figure 	NF _{min}		0.95			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		17.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		30.5			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \text{ G}$
• 1 dB gain compression point at output	OP _{1dB}		17			

Table 11 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 2.4 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		17.5			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		15			
Noise figure						
Minimum noise figure	NF _{min}		1			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		15			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		30			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		17			

Table 12 AC characteristics, $V_{CE} = 3 \text{ V}, f = 3.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		14.5			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		11.5			
Noise figure						
Minimum noise figure	NF _{min}		1.2			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		11.5			
Linearity					dBm	
3rd order intercept point at output	OIP ₃		30			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$
$\bullet \hspace{0.5cm} 1 dB gain compression point at output$	OP _{1dB}		17			

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Electrical characteristics

Table 13 AC characteristics, $V_{CE} = 3 \text{ V}$, f = 5.5 GHz

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Тур.	Max.		
Power gain		_		_	dB	
Maximum power gain	G _{ms}		10.5			$I_{\rm C} = 70 {\rm mA}$
Transducer gain	$ S_{21} ^2$		7			
Noise figure						
Minimum noise figure	NF _{min}		1.6			$I_{\rm C} = 30 {\rm mA}$
Associated gain	G _{ass}		8.5			
Linearity					dBm	
 3rd order intercept point at output 	OIP ₃		29.5			$I_{\rm C} = 70 \text{ mA}, Z_{\rm S} = Z_{\rm L} = 50 \Omega$
• 1 dB gain compression point at output	OP _{1dB}		16.5			

Note:

 $G_{\rm ms}$ = $IS_{21}/S_{12}I$ for k < 1; $G_{\rm ma}$ = $IS_{21}/S_{12}I$ (k-(k^2 -1) $^{1/2}$) for k > 1. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP₃ value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50 Ω from 0.2 MHz to 12 GHz.



3.4 Characteristic DC diagrams

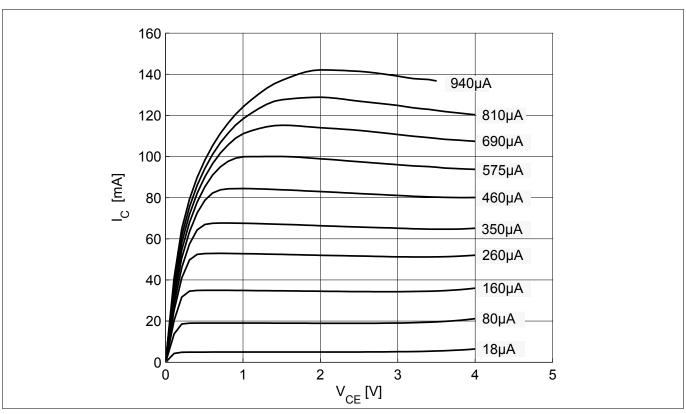


Figure 3 Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, $I_B = parameter$

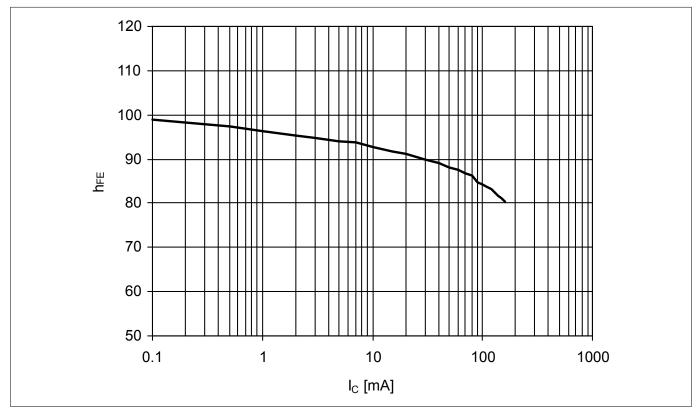


Figure 4 DC current gain $h_{FE} = f(I_C)$, $V_{CE} = 3 \text{ V}$



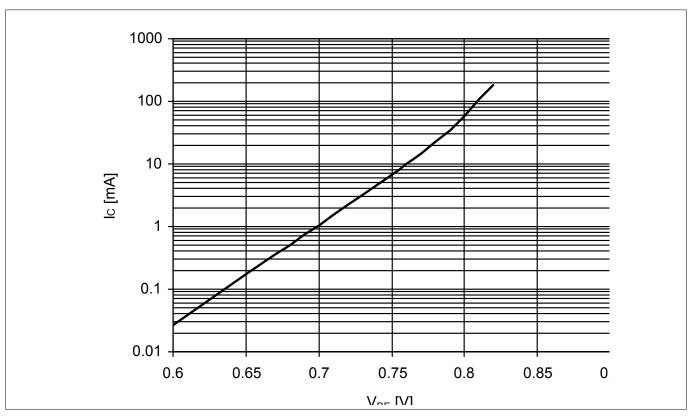


Figure 5 Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 2 \text{ V}$

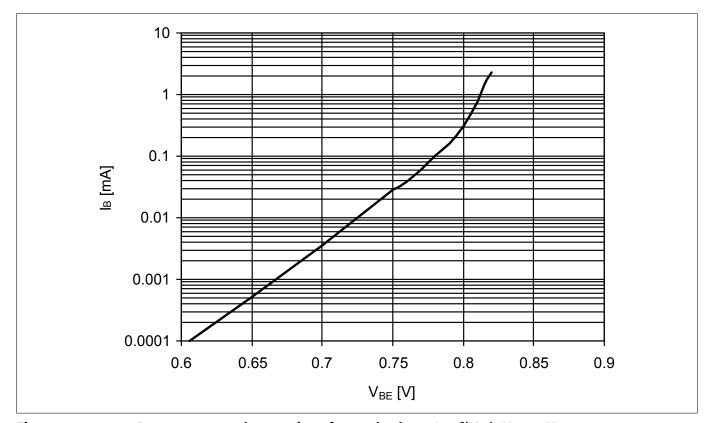


Figure 6 Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 2 \text{ V}$

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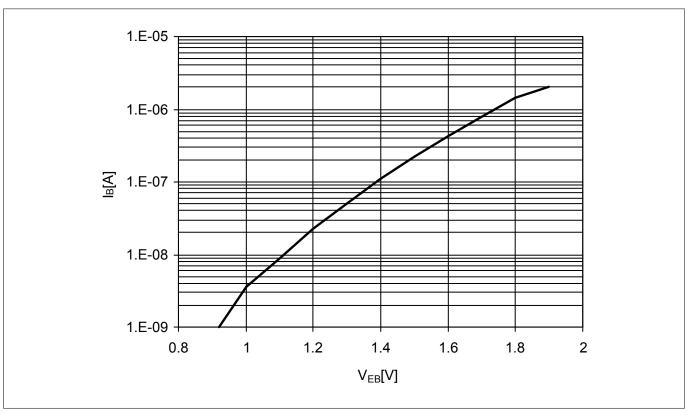


Figure 7 Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 2 \text{ V}$



3.5 Characteristic AC diagrams

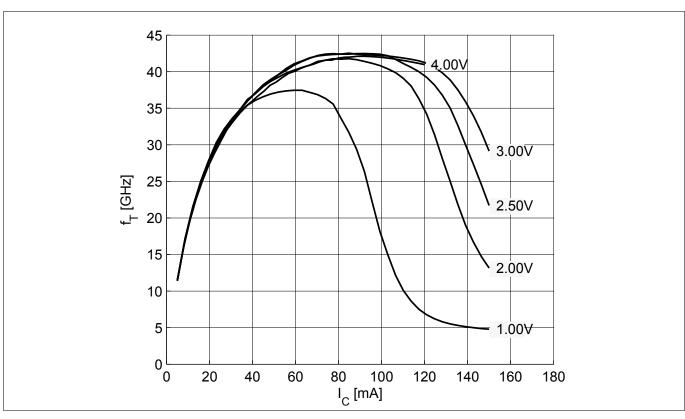


Figure 8 Transition frequency $f_T = f(I_C)$, f = 1 GHz, $V_{CE} =$ parameter

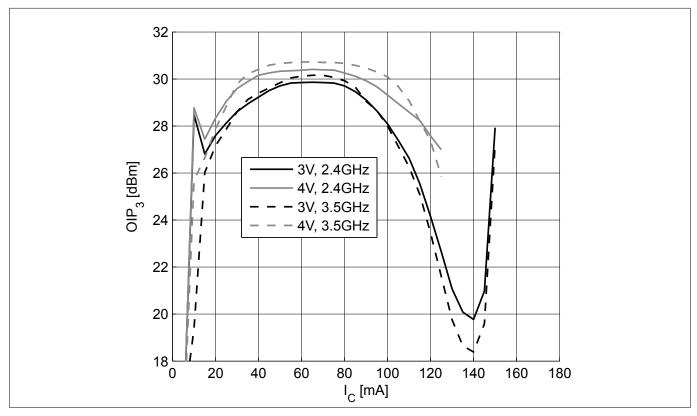


Figure 9 3rd order intercept point $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , f = parameters



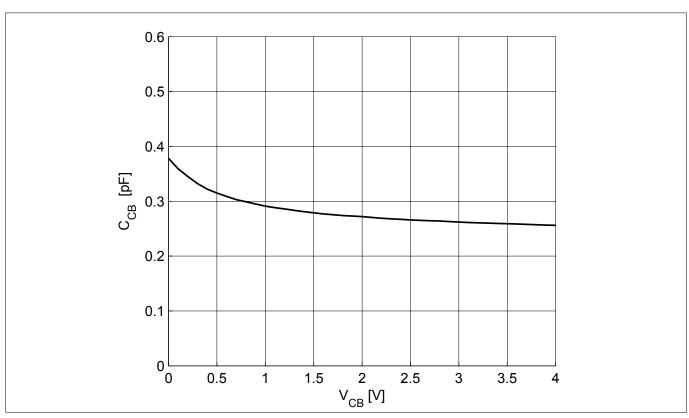


Figure 10 Collector base capacitance $C_{CB} = f(V_{CB}), f = 1 \text{ MHz}$

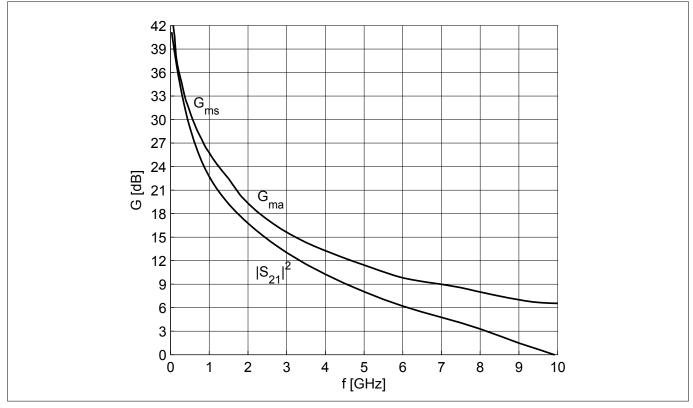


Figure 11 Gain G_{ma} , G_{ms} , $IS_{21}I^2 = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 70 \text{ mA}$



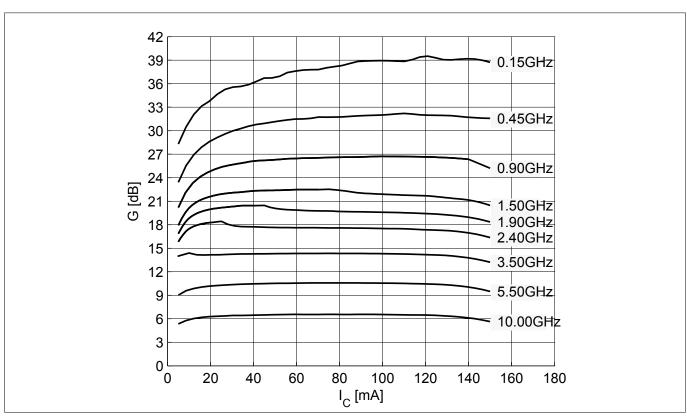


Figure 12 Maximum power gain $G_{\text{max}} = f(I_{\text{C}})$, $V_{\text{CE}} = 3 \text{ V}$, f = parameter in GHz

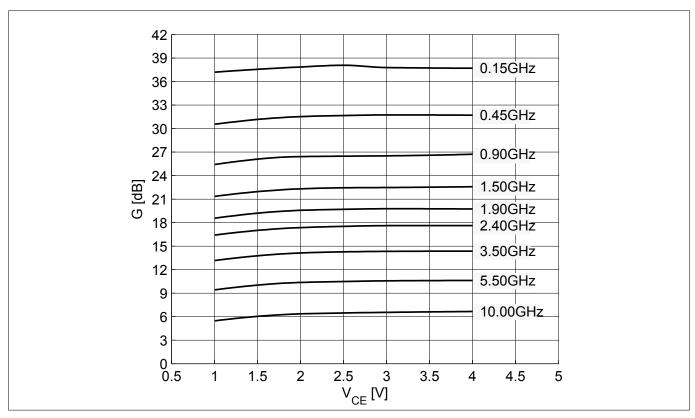
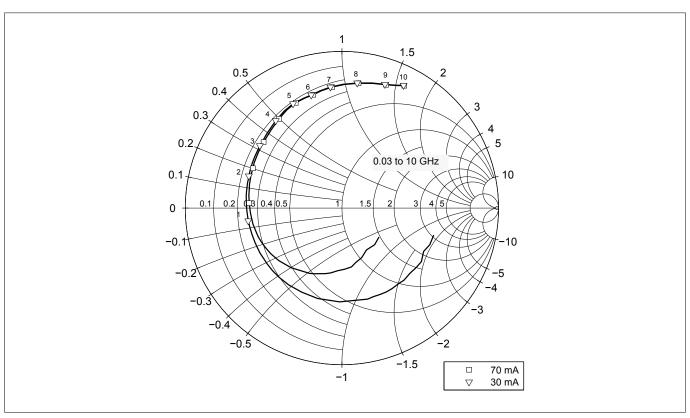
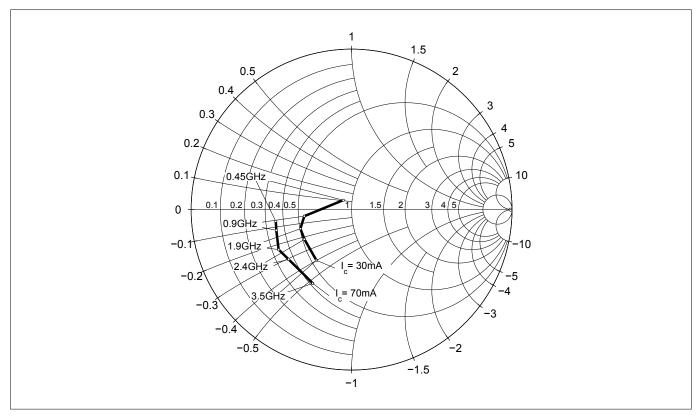


Figure 13 Maximum power gain $G_{\text{max}} = f(V_{\text{CE}})$, $I_{\text{C}} = 70 \text{ mA}$, f = parameter in GHz





Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 30 \text{ / } 70 \text{ mA}$ Figure 14



Source impedance for minimum noise figure $Z_{S,opt} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_C = 30 \text{ / } 70 \text{ mA}$ Figure 15



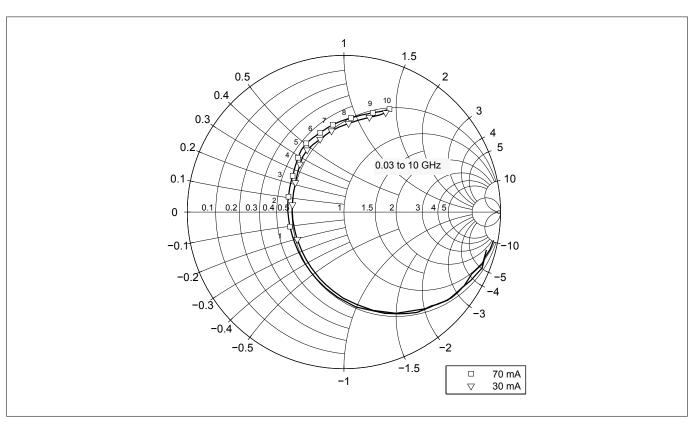


Figure 16 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 3 \text{ V}$, $I_{C} = 30 / 70 \text{ mA}$

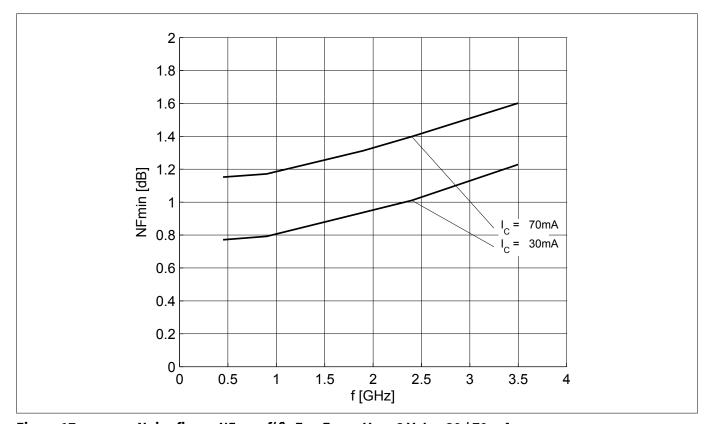


Figure 17 Noise figure $NF_{min} = f(f)$, $Z_S = Z_{S,opt}$, $V_{CE} = 3 \text{ V}$, $I_C = 30 \text{ / } 70 \text{ mA}$



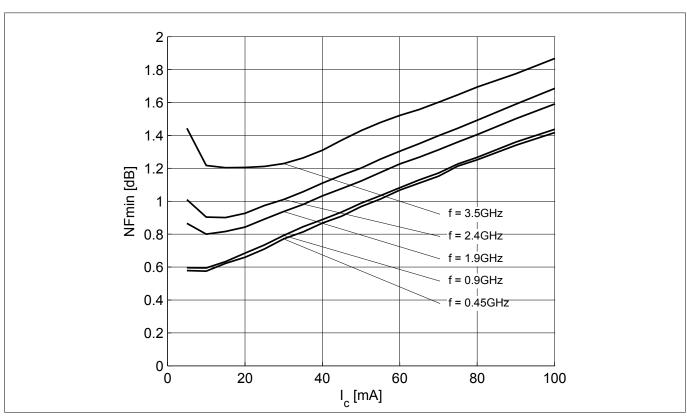


Figure 18 Noise figure $NF_{min} = f(I_C)$, $Z_S = Z_{S,opt}$, $V_{CE} = 3 \text{ V}$, f = parameter in GHz

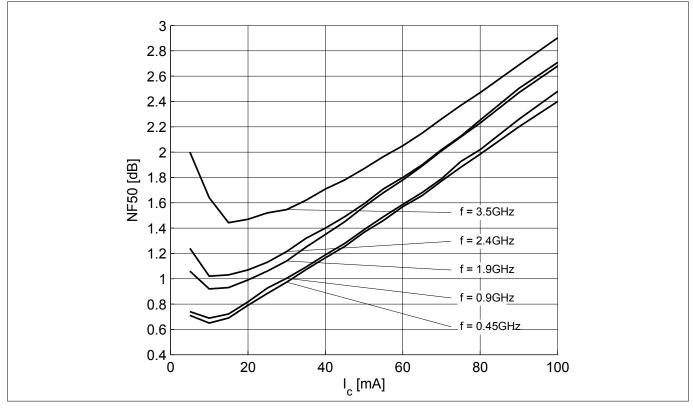


Figure 19 Noise figure $NF_{50} = f(I_C)$, $Z_S = 50 \Omega$, $V_{CE} = 3 V$, f = parameter in GHz



Electrical characteristics

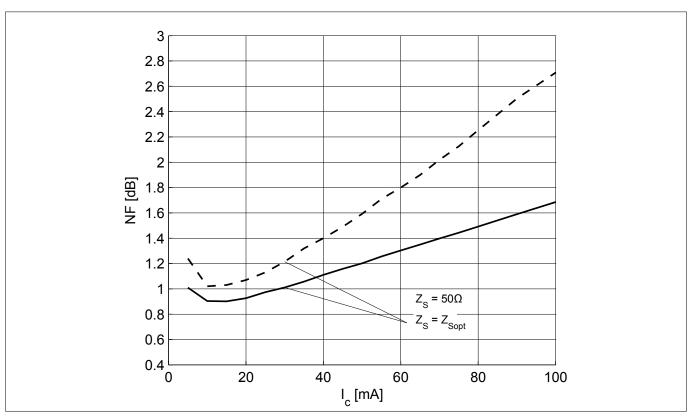


Figure 20 Noise figure $NF_{50} = f(I_C)$, $Z_S = 50 \Omega$, $NF_{min} = f(I_C)$, $Z_S = Z_{S,opt}$, $V_{CE} = 3 V$, f = 2.4 GHz

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25 \,^{\circ}\text{C}$.



Package information SOT343

4 Package information SOT343

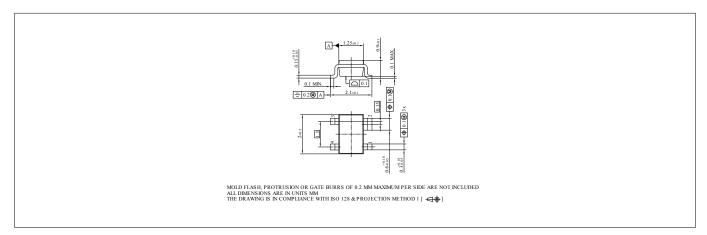


Figure 21 Package outline

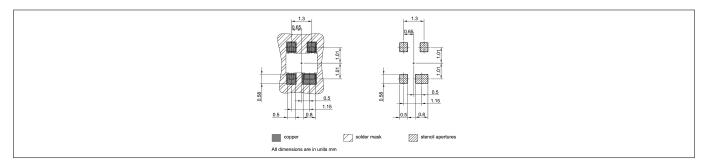


Figure 22 Foot print

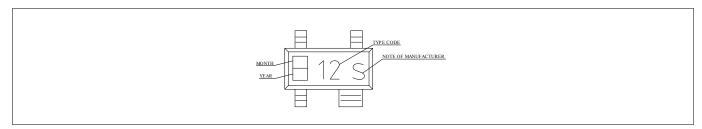


Figure 23 Marking layout example

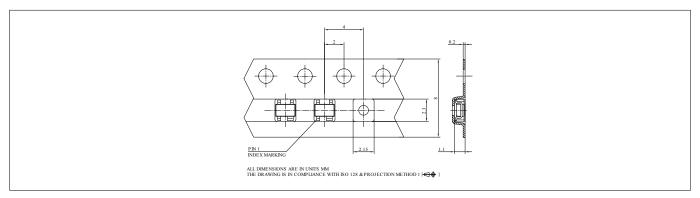


Figure 24 Tape dimensions

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Revision history

Revision history

Document version	Date of release	Description of changes
Revision 2.0	2019-01-25	New datasheet layout.

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